

COMBINED DECLARATION AND POWER OF ATTORNEY FOR UTILITY PATENT APPLICATION

As a below-named inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention titled:

Semiconductor multi-package module having package stacked over ball grid array package and having wire bond interconnect between stacked packages

tne spe	cification of which				
	is attached hereto.				
	and was amend	ded on (<i>if applicable</i>).			
specific		have reviewed and units, as amended by any an			ove-identified
"Each in good fa that ind known patenta	tion in accordance with T ndividual associated with lith in dealing with the O lividual to be material to to be material to patent	ty to disclose information itle 37, Code of Federal Foother the filing and prosecution ffice, which includes a durant patentability as defined in a patent was cited by discounty.	Regulations, § 1.56(a) we not a patent application by to disclose to the Offenthis sectionThe dute satisfied if all information	which states in ron has a duty of fice all informating to disclose all on known to be	elevant part: f candor and ion known to Il information e material to
foreign	tion(s) for patent or inv	priority benefits under Ti entor's certificate as indi inventor's certificate on t laimed:	cated below and have	e also identified	d below any
	Prior Foreign Application(s)			Priority Claimed	
				☐ Yes	☐ No
	(Number) (Country) (Day/Month/Year Filed)		_	
	(Number) (Country) (Doy/Month Wood Filed)		☐ Yes	☐ No
·	(Number) (Country) (Day/Month/Tear Filed)			
applicated disclosed United Code of the co	tion(s), and under Title tion(s), listed below and, ed in the prior United Si States Code, § 112, I ad f Federal Regulations, §	enefit under Title 35, United States Codinsofar as the subject matates application in the macknowledge the duty to dis 1.56(a) which occurred the liling date of this application.	de, § 119(e) of any atter of each of the clais anner provided by the isclose material informotive the filing date.	United States ms of this applie first paragraph ation as defined	provisional ication is not n of Title 35, d in Title 37,
	60/411,590	17 September 2002	Pending		
•	(Application No.)	Filing Date)	(Status: Patented, Pe	ending, Abando	ned)
	(Application No.)	(Filing Date)	(Status: Patented, Pe	ending, Abando	ned)
	(Application No.)	(Filing Date)	(Status: Patented, Pe	ending, Abando	ned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith, and to file, prosecute and to transact all business in connection with international applications directed to said invention:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor:

Marcos Karnezos

Inventor's signature:

Date:

Citizenship:

Mailing Address:

Date:

Date:

U.S.A.

Mailing Address:

Date:

Date:

Same as above